

TIS/MADRID ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.1

MADRID ID: MD238970

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNS THE ENTIRE INTEREST AND THE GOODWILL	
CONVEYING PARTY DATA		
	Name	Execution Date
	HUAWEI TECHNOLOGIES CO., LTD.	08/26/2021
RECEIVING PARTY DATA		
Name:	Honor Device Co., Ltd.	
Address:	Suite 3401, Unit A, Building 6, Shum Yip Sky Park, No. 8089, Hongli West Road, Xiangmihu Street, Futian District, Shenzhen 518040 Guangdong	
Country:	CN	
Entity Type:	Limited Company	
Entity Country:	China	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Serial Number:	79319616
CORRESPONDENCE DATA		
Correspondent Name:	Honor Device Co., Ltd.	
Address:	Suite 3401, Unit A, Building 6, Shum Yip Sky Park, No. 8089, Hongli West Road, Xiangmihu Street, Futian District, Shenzhen 518040 Guangdong	
Country:	CN	

**THIS
PAGE
INTENTIONALLY
LEFT
BLANK**